

Data Sheet



CMA3000-D01 3-AXIS ULTRA LOW POWER ACCELEROMETER WITH DIGITAL SPI AND I²C INTERFACE

Features

- 1.7 V – 3.6 V supply voltage
- SPI and I²C digital interface
- User selectable
 - ± 2 g and ± 8 g measurement ranges
 - sample rate & frequency response
- Ultra low current consumption
 - ≤ 70 μ A with 100/400 Hz sample rate
 - ≤ 11 μ A with 40/10Hz sample rate
- Interrupt signal triggered by data ready, motion and free fall
- Size 2x2x0.95 mm³
- Proven capacitive 3D-MEMS technology
- High shock durability
- RoHS compliant / lead free soldering

Applications

CMA3000-D01 is targeted to battery operated devices. Typical applications are but not limited

- Gaming input devices
- Computer peripherals
- Free fall detection
- Activity monitoring

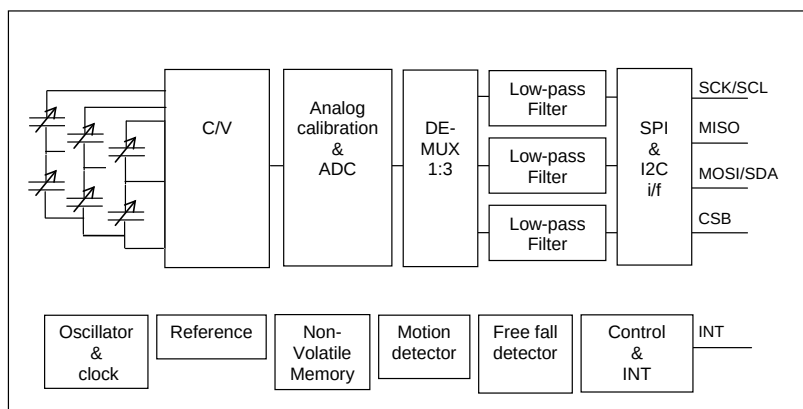


Figure 1. CMA3000-D01 Block Diagram.

Performance Characteristics ¹⁾

Parameter	Condition	Typical supply range 1.7 – 2.7 V			Extended supply range 2.7 – 3.6 V			Units
		Min	Typ ²⁾	Max	Min	Typ ²⁾	Max	
Vdd		1.7	2.5	2.7	-	3.3	-	V
Digital I/O Vdd	Vdd ≥ Digital I/O Vdd	1.7	1.8 / 2.5	2.7	-	3.3	-	V
Operating temperature **		-40	-	85	-40	-	85	°C
Current consumption *	ODR=400 Hz	-	70	90	-	70	-	μA
	ODR=100 Hz	-	50	-	-	50	-	
	ODR=40 Hz	-	11	-	-	14	-	
	ODR=10 Hz	-	7	-	-	9	-	
	Power down	-	3	9	-	4	-	
Acceleration range *	G_RANGE bit 0	-8	-	8	-	±8	-	G
	G_RANGE bit 1	-2	-	2	-	±2	-	
Offset calibration error * ³⁾	G_RANGE bit 1	-100	±25	+100	-	±100	-	mg
Offset temperature error ** ⁴⁾	-40 ... +85 °C	-	±1	-	-	±1	-	mg/°C
	X and Z axis Y axis	-	±2.5	-	-	±2.5	-	
Sensitivity * ⁵⁾	Full scale=2g, ODR=400Hz	-	56	-	-	56	-	Count/g
	Full scale=8g	-	14	-	-	14	-	
Sensitivity calibration error *		-10	-	+10	-	±10	-	%
Sensitivity temperature error ** ⁶⁾	-40 ... +85 °C	-	±0.02	-	-	±0.02	-	%/°C
Non-Linearity ** ⁷⁾		-	1.5	3	-	1.5	-	% FS
Cross-Axis sensitivity ** ⁸⁾	G_RANGE bit 1	-	1	-	-	1	-	%
Output Data Rate, ODR **	MODE bits x10	340	400	460	340	400	460	Hz
	MODE bits x01	-	100	-	-	100	-	
	MODE bits 011	-	40	-	-	40	-	
	MODE bits 100	-	10	-	-	10	-	
Bandwidth** ⁹⁾		-	ODR/5	-	-	ODR/5	-	Hz
Noise ** ¹⁰⁾	Full scale=2g, ODR=100Hz	-	13	-	-	13	-	mg RMS
	Full scale=8g, ODR=400Hz	-	25	-	-	25	-	
Turn on time ** ¹¹⁾	ODR=400 Hz	-	0.01	-	-	0.01	-	s
	ODR≤100 Hz	-	2.5/ODR	-	-	2.5/ODR	-	
I ² C clock rate **		-	-	400	-	-	400	kHz
SPI clock rate **		-	-	500	-	-	500	kHz

* 100% tested in production

** Qualified during product validation

1) The product is factory calibrated at 2.5 V in room temperature.

2) Typical values are not guaranteed.

3) Z-axis +1g position. Soldering process can cause offset shift which is typically less than 150 mg. Please see TN68_CMA3000_Assembly_Instructions for further details.

4) Offset temperature error = {Count(0g)-Offset} / Sensitivity [g]. Sensitivity = Calibrated sensitivity. Offset= Calibrated offset.

5) Sensitivity = {Count(+1g) - Count(-1g)}/2 [Count/g].
With Full scale = 2g, ODR=100 Hz the nominal sensitivity is 50.5 Count/g.

6) Sensitivity temperature error = {[Count(+1g)-Count(-1g)]/2 - Sensitivity} / Sensitivity x 100% [%].
Sensitivity = Calibrated sensitivity.

7) Best fit straight line.

8) The cross-axis sensitivity determines how much acceleration, perpendicular to the measuring axis, couples to the output. The total cross-axis sensitivity is the geometric sum of the sensitivities of the two axes which are perpendicular to the measuring axis. The angular alignment error between X, Y and Z axis is included into the cross axis sensitivity.

9) Frequency responses with 1st order roll off according to Figure 3.

10) Average noise/axis over the measurement bandwidth defined as $\sqrt{\frac{1}{3}(n_x^2 + n_y^2 + n_z^2)}$, where n_x , n_y and n_z are

the measured signal's standard deviation due to noise in x, y and z directions.

11) Settling error less than 1% of FS.

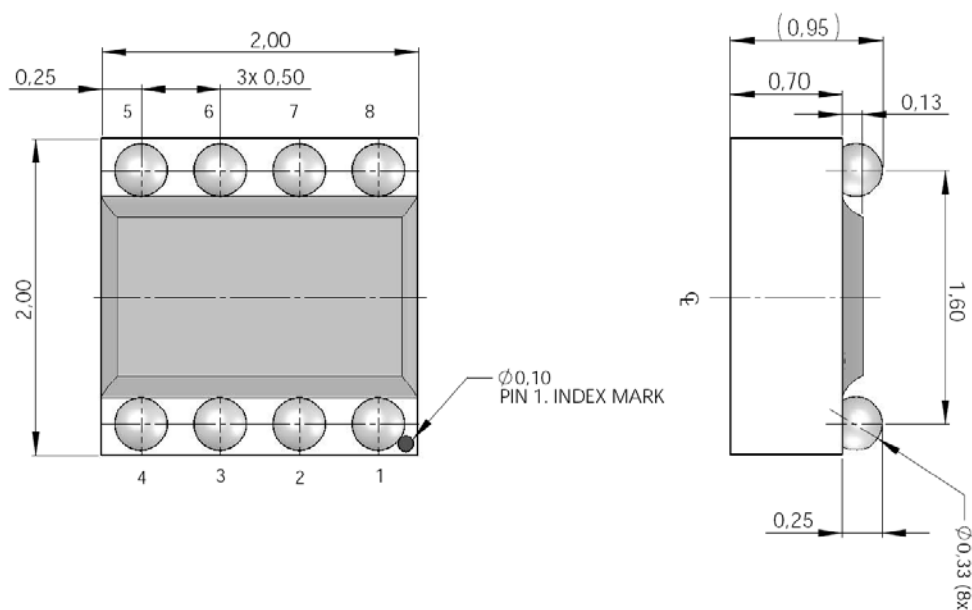


Figure 2. Package dimensions in mm with $\pm 50 \mu\text{m}$ tolerance.

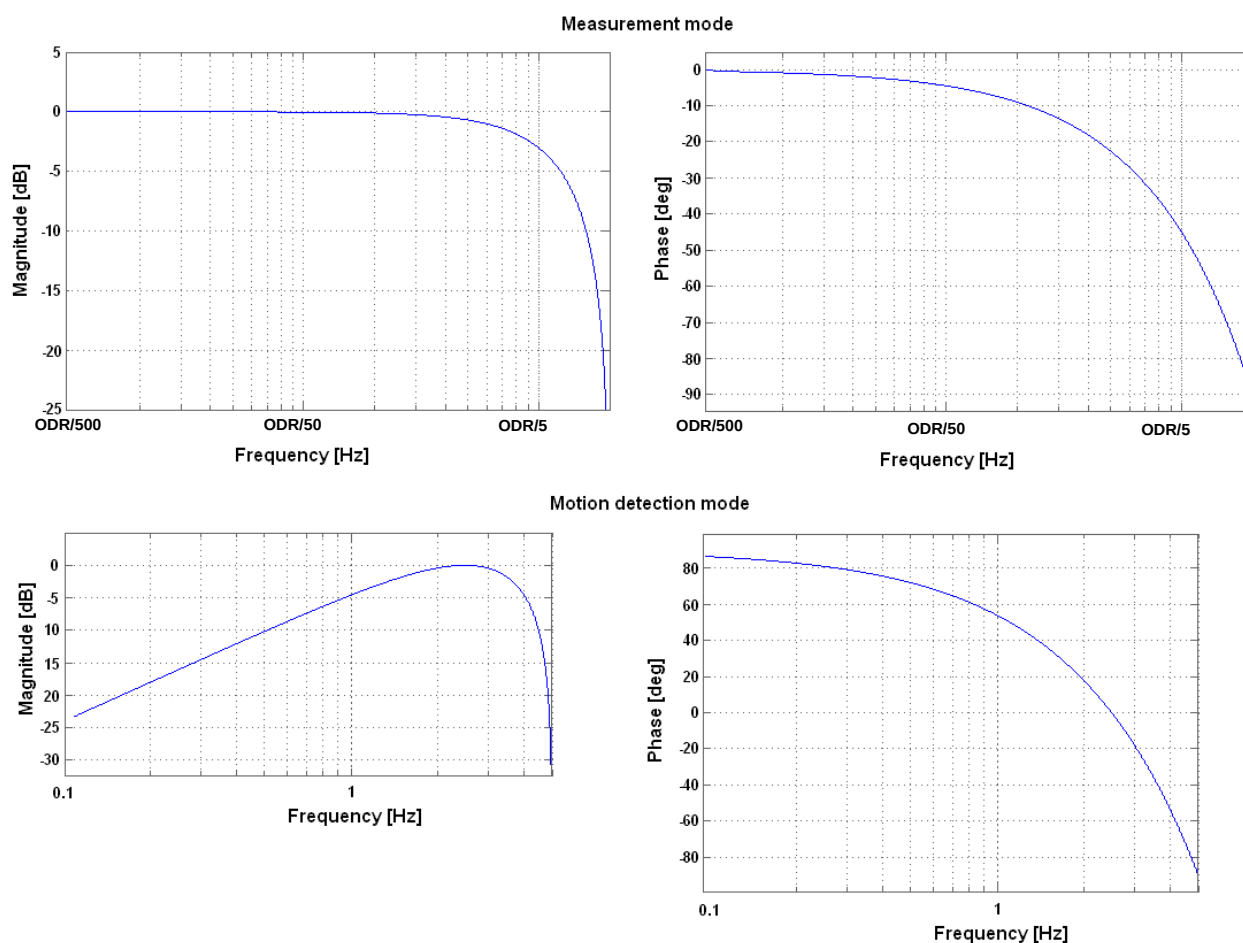


Figure 3. Typical Frequency responses of CMA3000-D01.

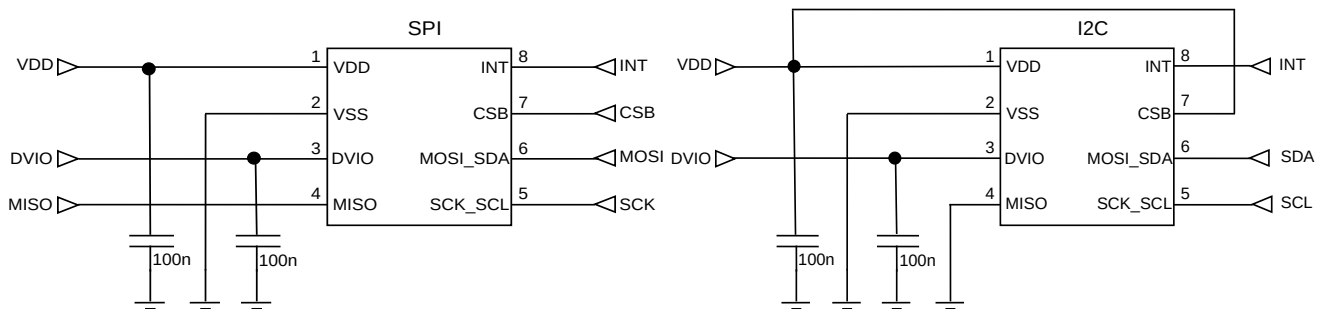


Figure 4. Application schematics for SPI and I²C bus.

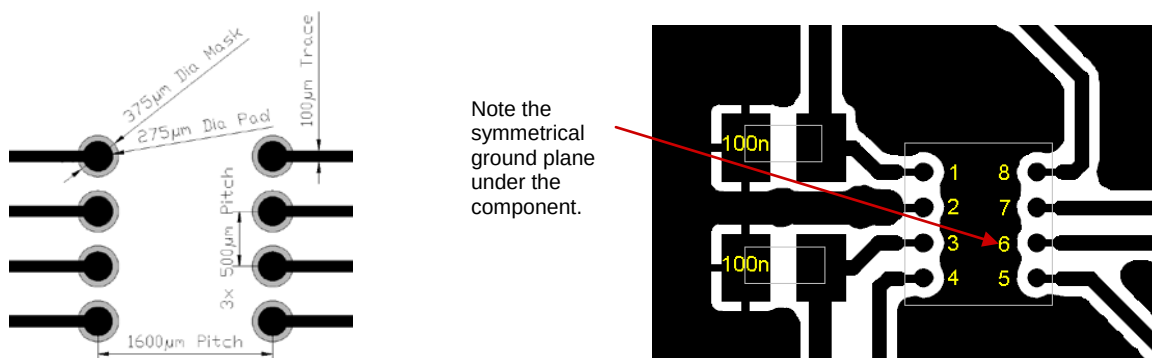


Figure 5. Recommended layout pattern (not actual size, for reference only).

Table 1. Pin descriptions.

Pin #	Name	Function
1	VDD	Supply voltage
2	VSS	Ground
3	DVIO	I/O Supply
4	MISO	SPI Serial Data Output (MISO)
5	SCK_SCL	SPI Serial Clock (SCK) / I ² C Serial Clock (SCL)
6	MOSI_SDA	SPI Serial Data Input (MOSI) / I ² C Serial Data (SDA)
7	CSB	Chip select / I ² C enable
8	INT	Interrupt

Document Change Control

Rev.	Date	Change Description
0.1	02-May-07	1 st version
...	...	...
0.13	29-Dec-08	Version for launch
0.14	12-Jun-09	Performance characteristics update
A.01	26-Oct-09	Release A
A.02	06-May-10	Performance characteristics update
A.03	01-Apr-11	Performance characteristics update
A.04	03-Aug-12	Update to Murata template.